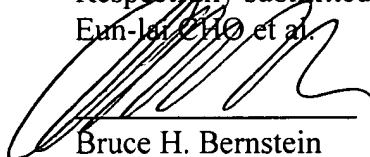


REMARKS

By the above amendment herein, the specification has been modified to even more accurately denote Japanese Patent Publication No. Hei 5-32491, which is being submitted on even date with the Information Disclosure Statement, and to include commas in the U.S. patents.

If there should be any questions, the Examiner is invited to contact the undersigned at the telephone number listed below.

Respectfully submitted,
Eun-lee CHO et al.



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**APPENDIX
MARKED-UP COPY OF AMENDMENT TO SPECIFICATION**

Marked-up copy to paragraph appearing at page 1, lines 18-22.

According to Japanese Patent [Laid-Open] Publication No. Hei. 5-32491 by Isoo Saito et al., a drawing temperature is 120°C, and U.S. Patent Nos. [4349501] 4,349,501 by Maxwell C. Hamlyn et al. and [4851172] 4,851,172 by Hugh H. Rowan et al. disclose a draw point localizing method with the use of steam at 300°C or higher.